

## APPLICATION DATA SHEET

### APPLICATION INFORMATION

Application Type:: REGULAR  
Subject Matter:: UTILITY  
CD-ROM or CD-R?:: NONE  
Title:: HERMETICALLY SEALED  
SEMICONDUCTOR POWER MODULE  
AND LARGE SCALE MODULE  
COMPRISING THE SAME  
Attorney Docket Number:: 248983US-2 DIV  
Total Drawing Sheets:: 14

### INVENTOR INFORMATION

Applicant Authority Type:: INVENTOR  
Primary Citizenship Country:: Japan  
Status:: FULL CAPACITY  
Given Name:: Michiaki  
Family Name:: HIYOSHI  
City of Residence:: Tokyo  
Country of Residence:: Japan  
Street of Mailing Address:: c/o Intellectual Property Division  
Toshiba Corporation  
1-1-1, Shibaura  
City of Mailing Address:: Minato-ku  
State or Province of Mailing Address:: Tokyo  
Country of Mailing Address:: Japan

### CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

### REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

### DOMESTIC PRIORITY INFORMATION

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Division of	09/917,876	07/31/01

09/917,876	Division of	09/311,055	05/14/99
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#### FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
10-133714	Japan	05/15/98	YES

#### ASSIGNMENT INFORMATION

Assignee Name::	KABUSHIKI KAISHA TOSHIBA
Street of Mailing Address::	1-1 Shibaura, 1 chome
City of Mailing Address::	Minato-ku
State or Province of Mailing Address::	Tokyo
Country of Mailing Address::	Japan